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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Active
Number of LABs/CLBs	176
Number of Logic Elements/Cells	1584
Total RAM Bits	55296
Number of I/O	108
Number of Gates	50000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	144-LQFP
Supplier Device Package	144-TQFP (20x20)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc3s50a-4tq144c

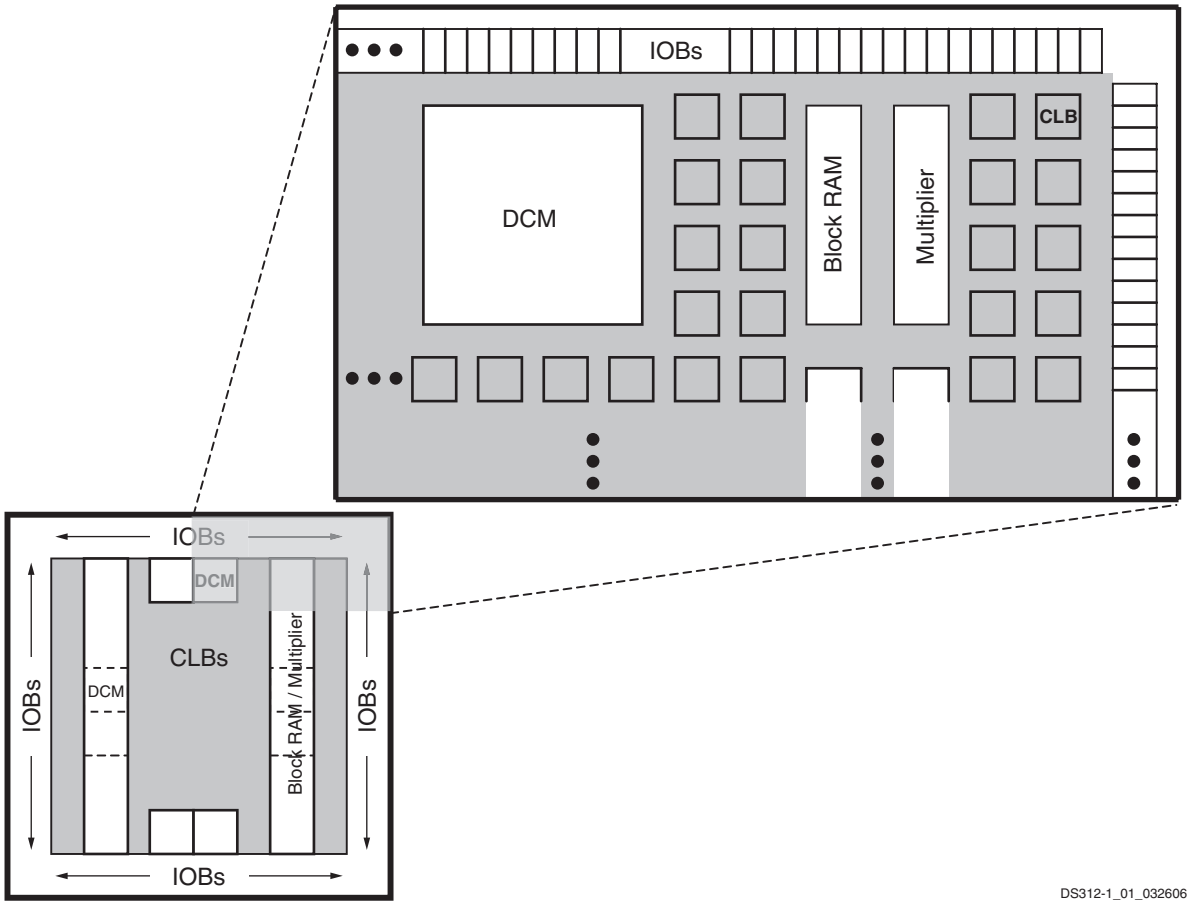
Architectural Overview

The Spartan-3A family architecture consists of five fundamental programmable functional elements:

- **Configurable Logic Blocks (CLBs)** contain flexible Look-Up Tables (LUTs) that implement logic plus storage elements used as flip-flops or latches. CLBs perform a wide variety of logical functions as well as store data.
- **Input/Output Blocks (IOBs)** control the flow of data between the I/O pins and the internal logic of the device. IOBs support bidirectional data flow plus 3-state operation. Supports a variety of signal standards, including several high-performance differential standards. Double Data-Rate (DDR) registers are included.
- **Block RAM** provides data storage in the form of 18-Kbit dual-port blocks.
- **Multiplier Blocks** accept two 18-bit binary numbers as inputs and calculate the product.
- **Digital Clock Manager (DCM) Blocks** provide self-calibrating, fully digital solutions for distributing, delaying, multiplying, dividing, and phase-shifting clock signals.

These elements are organized as shown in Figure 1. A dual ring of staggered IOBs surrounds a regular array of CLBs. Each device has two columns of block RAM except for the XC3S50A, which has one column. Each RAM column consists of several 18-Kbit RAM blocks. Each block RAM is associated with a dedicated multiplier. The DCMs are positioned in the center with two at the top and two at the bottom of the device. The XC3S50A has DCMs only at the top, while the XC3S700A and XC3S1400A add two DCMs in the middle of the two columns of block RAM and multipliers.

The Spartan-3A family features a rich network of routing that interconnect all five functional elements, transmitting signals among them. Each functional element has an associated switch matrix that permits multiple connections to the routing.



Notes:

1. The XC3S700A and XC3S1400A have two additional DCMs on both the left and right sides as indicated by the dashed lines. The XC3S50A has only two DCMs at the top and only one Block RAM/Multiplier column.

Figure 1: **Spartan-3A FPGA Architecture**

Configuration

Spartan-3A FPGAs are programmed by loading configuration data into robust, reprogrammable, static CMOS configuration latches (CCLs) that collectively control all functional elements and routing resources. The FPGA's configuration data is stored externally in a PROM or some other non-volatile medium, either on or off the board. After applying power, the configuration data is written to the FPGA using any of seven different modes:

- Master Serial from a Xilinx Platform Flash PROM
- Serial Peripheral Interface (SPI) from an industry-standard SPI serial Flash
- Byte Peripheral Interface (BPI) Up from an industry-standard x8 or x8/x16 parallel NOR Flash
- Slave Serial, typically downloaded from a processor
- Slave Parallel, typically downloaded from a processor
- Boundary Scan (JTAG), typically downloaded from a processor or system tester

Furthermore, Spartan-3A FPGAs support MultiBoot configuration, allowing two or more FPGA configuration bitstreams to be stored in a single SPI serial Flash or a BPI parallel NOR Flash. The FPGA application controls which configuration to load next and when to load it.

Additionally, each Spartan-3A FPGA contains a unique, factory-programmed Device DNA identifier useful for tracking purposes, anti-cloning designs, or IP protection.

I/O Capabilities

The Spartan-3A FPGA SelectIO interface supports many popular single-ended and differential standards. Table 2 shows the number of user I/Os as well as the number of differential I/O pairs available for each device/package combination. Some of the user I/Os are unidirectional input-only pins as indicated in Table 2.

Spartan-3A FPGAs support the following single-ended standards:

- 3.3V low-voltage TTL (LVTTL)
- Low-voltage CMOS (LVCMOS) at 3.3V, 2.5V, 1.8V, 1.5V, or 1.2V
- 3.3V PCI at 33 MHz or 66 MHz
- HSTL I, II, and III at 1.5V and 1.8V, commonly used in memory applications
- SSTL I and II at 1.8V, 2.5V, and 3.3V, commonly used for memory applications

Spartan-3A FPGAs support the following differential standards:

- LVDS, mini-LVDS, RSDS, and PPDS I/O at 2.5V or 3.3V
- Bus LVDS I/O at 2.5V
- TMDS I/O at 3.3V
- Differential HSTL and SSTL I/O
- LVPECL inputs at 2.5V or 3.3V

Table 2: **Available User I/Os and Differential (Diff) I/O Pairs**

Package	VQ100 VQG100		TQ144 TQG144		FT256 FTG256		FG320 FGG320		FG400 FGG400		FG484 FGG484		FG676 FGG676	
Body Size (mm)	14 x 14(2)		20 x 20(2)		17 x 17		19 x 19		21 x 21		23 x 23		27 x 27	
Device	User	Diff	User	Diff	User	Diff	User	Diff	User	Diff	User	Diff	User	Diff
XC3S50A	**68** *(13)*	**60** *(24)*	**108** *(7)*	**50** *(24)*	**144** *(32)*	**64** *(32)*	-	-	-	-	-	-	-	-
XC3S200A	**68** *(13)*	**60** *(24)*	-	-	**195** *(35)*	**90** *(50)*	**248** *(56)*	**112** *(64)*	-	-	-	-	-	-
XC3S400A	-	-	-	-	**195** *(35)*	**90** *(50)*	**251** *(59)*	**112** *(64)*	**311** *(63)*	**142** *(78)*	-	-	-	-
XC3S700A	-	-	-	-	**161** *(13)*	**74** *(36)*	-	-	**311** *(63)*	**142** *(78)*	**372** *(84)*	**165** *(93)*	-	-
XC3S1400A	-	-	-	-	**161** *(13)*	**74** *(36)*	-	-	-	-	**375** *(87)*	**165** *(93)*	**502** *(94)*	**227** *(131)*

Notes:

1. The number shown in **bold** indicates the maximum number of I/O and input-only pins. The number shown in (*italics*) indicates the number of input-only pins. The differential (Diff) input-only pin count includes both differential pairs on input-only pins and differential pairs on I/O pins within I/O banks that are restricted to differential inputs.
2. The footprints for the VQ/TQ packages are larger than the package body. See the Package Drawings for details.

Production Status

Table 3 indicates the production status of each Spartan-3A FPGA by temperature range and speed grade. The table also lists the earliest speed file version required for creating a production configuration bitstream. Later versions are also supported.

Table 3: **Spartan-3A FPGA Production Status (Production Speed File)**

Temperature Range		Commercial (C)		Industrial
Speed Grade		Standard (–4)	High-Performance (–5)	Standard (–4)
Part Number	XC3S50A	**Production** (v1.35)	**Production** (v1.35)	**Production** (v1.35)
	XC3S200A	**Production** (v1.35)	**Production** (v1.35)	**Production** (v1.35)
	XC3S400A	**Production** (v1.36)	**Production** (v1.36)	**Production** (v1.36)
	XC3S700A	**Production** (v1.34)	**Production** (v1.35)	**Production** (v1.34)
	XC3S1400A	**Production** (v1.34)	**Production** (v1.35)	**Production** (v1.34)

Package Marking

Figure 2 provides a top marking example for Spartan-3A FPGAs in the quad-flat packages. Figure 3 shows the top marking for Spartan-3A FPGAs in BGA packages. The markings for the BGA packages are nearly identical to those for the quad-flat packages, except that the marking is rotated with respect to the ball A1 indicator.

The "5C" and "4I" Speed Grade/Temperature Range part combinations may be dual marked as "5C/4I". Devices with a single mark are only guaranteed for the marked speed grade and temperature range.

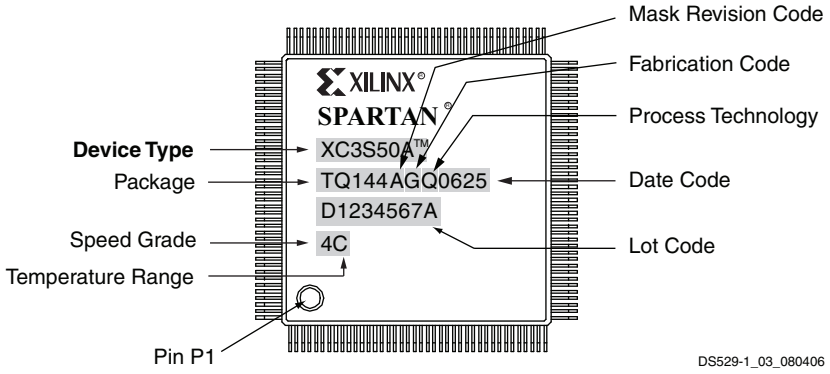


Figure 2: **Spartan-3A QFP Package Marking Example**

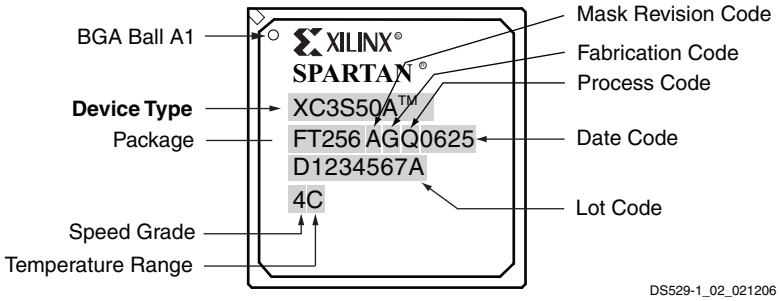
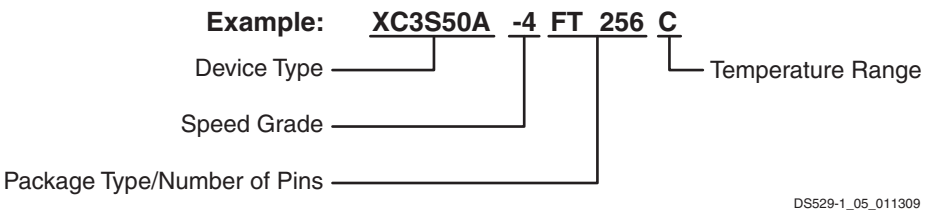


Figure 3: **Spartan-3A BGA Package Marking Example**

Ordering Information

Spartan-3A FPGAs are available in both standard and Pb-free packaging options for all device/package combinations. The Pb-free packages include a ‘G’ character in the ordering code.



Device	Speed Grade		Package Type / Number of Pins[1]		Temperature Range (T_J)	
XC3S50A	–4	Standard Performance	VQ100/ VQG100	100-pin Very Thin Quad Flat Pack (VQFP)	C	Commercial (0°C to 85°C)
XC3S200A	–5	High Performance (Commercial only)	TQ144/ TQG144	144-pin Thin Quad Flat Pack (TQFP)	I	Industrial (–40°C to 100°C)
XC3S400A			FT256/ FTG256	256-ball Fine-Pitch Thin Ball Grid Array (FTBGA)		
XC3S700A			FG320/ FGG320	320-ball Fine-Pitch Ball Grid Array (FBGA)		
XC3S1400A			FG400/ FGG400	400-ball Fine-Pitch Ball Grid Array (FBGA)		
			FG484/ FGG484	484-ball Fine-Pitch Ball Grid Array (FBGA)		
			FG676 FGG676	676-ball Fine-Pitch Ball Grid Array (FBGA)		

Notes:

1. See Table 2 for specific device/package combinations.
2. See DS681 for the XA Automotive Spartan-3A FPGAs.

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
12/05/06	1.0	Initial release.
02/02/07	1.1	Promoted to Preliminary status. Updated maximum differential I/O count for XC3S50A in Table 1. Updated differential input-only pin counts in Table 2.
03/16/07	1.2	Minor formatting updates.
04/23/07	1.3	Added "Production Status" section.
05/08/07	1.4	Updated XC3S400A to Production.
07/10/07	1.4.1	Minor updates.
04/15/08	1.6	Added VQ100 for XC3S50A and XC3S200A and extended FT256 to XC3S700A and XC3S1400A Added reference to SCD 4103 for 750 Mbps performance.
05/28/08	1.7	Added reference to XA Automotive version.
03/06/09	1.8	Simplified Ordering Information. Added references to Extended Spartan-3A Family. Removed reference to SCD 4103.
08/19/10	2.0	Updated Table 2 to clarify TQ/VQ size.

Single-Ended I/O Standards

Table 11: **Recommended Operating Conditions for User I/Os Using Single-Ended Standards**

IOSTANDARD Attribute	V_{CCO} for Drivers(2)			V_{REF}			V_{IL}	V_{IH}
	Min (V)	Nom (V)	Max (V)	Min (V)	Nom (V)	Max (V)	Max (V)	Min (V)
LVTTL	3.0	3.3	3.6	V_{REF} is not used for these I/O standards			0.8	2.0
LVCMOS33(4)	3.0	3.3	3.6				0.8	2.0
LVCMOS25(4,5)	2.3	2.5	2.7				0.7	1.7
LVCMOS18	1.65	1.8	1.95				0.4	0.8
LVCMOS15	1.4	1.5	1.6				0.4	0.8
LVCMOS12	1.1	1.2	1.3				0.4	0.7
PCI33_3(6)	3.0	3.3	3.6				0.3 • V_{CCO}	0.5 • V_{CCO}
PCI66_3(6)	3.0	3.3	3.6				0.3 • V_{CCO}	0.5 • V_{CCO}
HSTL_I	1.4	1.5	1.6	0.68	0.75	0.9	V_{REF} – 0.1	V_{REF} + 0.1
HSTL_III	1.4	1.5	1.6	–	0.9	-	V_{REF} – 0.1	V_{REF} + 0.1
HSTL_I_18	1.7	1.8	1.9	0.8	0.9	1.1	V_{REF} – 0.1	V_{REF} + 0.1
HSTL_II_18	1.7	1.8	1.9	–	0.9	–	V_{REF} – 0.1	V_{REF} + 0.1
HSTL_III_18	1.7	1.8	1.9	–	1.1	–	V_{REF} – 0.1	V_{REF} + 0.1
SSTL18_I	1.7	1.8	1.9	0.833	0.900	0.969	V_{REF} – 0.125	V_{REF} + 0.125
SSTL18_II	1.7	1.8	1.9	0.833	0.900	0.969	V_{REF} – 0.125	V_{REF} + 0.125
SSTL2_I	2.3	2.5	2.7	1.13	1.25	1.38	V_{REF} – 0.150	V_{REF} + 0.150
SSTL2_II	2.3	2.5	2.7	1.13	1.25	1.38	V_{REF} – 0.150	V_{REF} + 0.150
SSTL3_I	3.0	3.3	3.6	1.3	1.5	1.7	V_{REF} – 0.2	V_{REF} + 0.2
SSTL3_II	3.0	3.3	3.6	1.3	1.5	1.7	V_{REF} – 0.2	V_{REF} + 0.2

Notes:

1. Descriptions of the symbols used in this table are as follows:
   V_{CCO} – the supply voltage for output drivers
   V_{REF} – the reference voltage for setting the input switching threshold
   V_{IL} – the input voltage that indicates a Low logic level
   V_{IH} – the input voltage that indicates a High logic level
2. In general, the V_{CCO} rails supply only output drivers, not input circuits. The exceptions are for LVCMOS25 inputs when V_{CCAUX} = 3.3V range and for PCI I/O standards.
3. For device operation, the maximum signal voltage (V_{IH} max) can be as high as V_{IN} max. See Table 8.
4. There is approximately 100 mV of hysteresis on inputs using LVCMOS33 and LVCMOS25 I/O standards.
5. All Dedicated pins (PROG_B, DONE, SUSPEND, TCK, TDI, TDO, and TMS) draw power from the V_{CCAUX} rail and use the LVCMOS25 or LVCMOS33 standard depending on V_{CCAUX}. The dual-purpose configuration pins use the LVCMOS standard before the User mode. When using these pins as part of a standard 2.5V configuration interface, apply 2.5V to the V_{CCO} lines of Banks 0, 1, and 2 at power-on as well as throughout configuration.
6. For information on PCI IP solutions, see www.xilinx.com/pci. The PCI IOSTANDARD is not supported on input-only pins. The PCIX IOSTANDARD is available and has equivalent characteristics but no PCI-X IP is supported.

Table 22: **Propagation Times for the IOB Input Path *(Continued)***

Symbol	Description	Conditions	DELAY_VALUE	Device	Speed Grade		Units
					-5	-4	
					Max	Max	
T_{IOPID}	The time it takes for data to travel from the Input pin to the I output with the input delay programmed	LVCMOS25(2)	5	XC3S1400A	3.17	3.52	ns
			6		3.52	3.92	ns
			7		3.82	4.18	ns
			8		4.10	4.57	ns
			9		3.84	4.31	ns
			10		4.20	4.79	ns
			11		4.46	5.06	ns
			12		4.87	5.51	ns
			13		5.07	5.73	ns
			14		5.43	6.08	ns
			15		5.73	6.33	ns
			16		6.01	6.77	ns
T_{IOPLI}	The time it takes for data to travel from the Input pin through the IFF latch to the I output with no input delay programmed	LVCMOS25(2)	IFD_DELAY_VALUE=0	XC3S50A	1.70	1.81	ns
				XC3S200A	1.85	2.04	ns
				XC3S400A	1.44	1.74	ns
				XC3S700A	1.48	1.74	ns
				XC3S1400A	1.50	1.97	ns
T_{IOPLID}	The time it takes for data to travel from the Input pin through the IFF latch to the I output with the input delay programmed	LVCMOS25(2)	1	XC3S50A	2.30	2.41	ns
			2		3.24	3.35	ns
			3		3.65	3.98	ns
			4		4.18	4.55	ns
			5		4.02	4.47	ns
			6		4.86	5.32	ns
			7		5.61	6.17	ns
			8		6.11	6.75	ns
			1	XC3S200A	2.19	2.43	ns
			2		2.86	3.16	ns
			3		3.52	4.01	ns
			4		4.02	4.60	ns
			5		3.83	4.43	ns
			6		4.70	5.46	ns
			7		5.48	6.33	ns
			8		5.99	6.94	ns
			1	XC3S400A	1.93	2.25	ns
			2		2.57	2.90	ns
			3		3.16	3.66	ns
			4		3.63	4.19	ns

Output Timing Adjustments

Table 26: **Output Timing Adjustments for IOB**

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
Single-Ended Standards					
LVTTL	Slow	2 mA	5.58	5.58	ns
		4 mA	3.16	3.16	ns
		6 mA	3.17	3.17	ns
		8 mA	2.09	2.09	ns
		12 mA	1.62	1.62	ns
		16 mA	1.24	1.24	ns
		24 mA	2.74(3)	2.74(3)	ns
	Fast	2 mA	3.03	3.03	ns
		4 mA	1.71	1.71	ns
		6 mA	1.71	1.71	ns
		8 mA	0.53	0.53	ns
		12 mA	0.53	0.53	ns
		16 mA	0.59	0.59	ns
		24 mA	0.60	0.60	ns
	QuietIO	2 mA	27.67	27.67	ns
		4 mA	27.67	27.67	ns
		6 mA	27.67	27.67	ns
		8 mA	16.71	16.71	ns
		12 mA	16.67	16.67	ns
		16 mA	16.22	16.22	ns
		24 mA	12.11	12.11	ns

Table 26: **Output Timing Adjustments for IOB*(Continued)***

Convert Output Time from LVCMOS25 with 12mA Drive and Fast Slew Rate to the Following Signal Standard (IOSTANDARD)			Add the Adjustment Below		Units
			Speed Grade		
			-5	-4	
LVCMOS33	Slow	2 mA	5.58	5.58	ns
		4 mA	3.17	3.17	ns
		6 mA	3.17	3.17	ns
		8 mA	2.09	2.09	ns
		12 mA	1.24	1.24	ns
		16 mA	1.15	1.15	ns
		24 mA	2.55(3)	2.55(3)	ns
	Fast	2 mA	3.02	3.02	ns
		4 mA	1.71	1.71	ns
		6 mA	1.72	1.72	ns
		8 mA	0.53	0.53	ns
		12 mA	0.59	0.59	ns
		16 mA	0.59	0.59	ns
		24 mA	0.51	0.51	ns
	QuietIO	2 mA	27.67	27.67	ns
		4 mA	27.67	27.67	ns
		6 mA	27.67	27.67	ns
		8 mA	16.71	16.71	ns
		12 mA	16.29	16.29	ns
		16 mA	16.18	16.18	ns
		24 mA	12.11	12.11	ns

Configurable Logic Block (CLB) Timing

Table 30: **CLB (SLICEM) Timing**

Symbol	Description	Speed Grade				Units
		-5		-4		
		Min	Max	Min	Max	
Clock-to-Output Times						
T_{CKO}	When reading from the FFX (FFY) Flip-Flop, the time from the active transition at the CLK input to data appearing at the XQ (YQ) output	–	0.60	–	0.68	ns
Setup Times						
T_{AS}	Time from the setup of data at the F or G input to the active transition at the CLK input of the CLB	0.18	–	0.36	–	ns
T_{DICK}	Time from the setup of data at the BX or BY input to the active transition at the CLK input of the CLB	1.58	–	1.88	–	ns
Hold Times						
T_{AH}	Time from the active transition at the CLK input to the point where data is last held at the F or G input	0	–	0	–	ns
T_{CKDI}	Time from the active transition at the CLK input to the point where data is last held at the BX or BY input	0	–	0	–	ns
Clock Timing						
T_{CH}	The High pulse width of the CLB's CLK signal	0.63	–	0.75	–	ns
T_{CL}	The Low pulse width of the CLK signal	0.63	–	0.75	–	ns
F_{TOG}	Toggle frequency (for export control)	0	770	0	667	MHz
Propagation Times						
T_{ILO}	The time it takes for data to travel from the CLB's F (G) input to the X (Y) output	–	0.62	–	0.71	ns
Set/Reset Pulse Width						
T_{RPW_CLB}	The minimum allowable pulse width, High or Low, to the CLB's SR input	1.33	–	1.61	–	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8.

Table 31: **CLB Distributed RAM Switching Characteristics**

Symbol	Description	-5		-4		Units
		Min	Max	Min	Max	
Clock-to-Output Times						
T_{SHCKO}	Time from the active edge at the CLK input to data appearing on the distributed RAM output	–	1.69	–	2.01	ns
Setup Times						
T_{DS}	Setup time of data at the BX or BY input before the active transition at the CLK input of the distributed RAM	–0.07	–	–0.02	–	ns
T_{AS}	Setup time of the F/G address inputs before the active transition at the CLK input of the distributed RAM	0.18	–	0.36	–	ns
T_{WS}	Setup time of the write enable input before the active transition at the CLK input of the distributed RAM	0.30	–	0.59	–	ns
Hold Times						
T_{DH}	Hold time of the BX and BY data inputs after the active transition at the CLK input of the distributed RAM	0.13	–	0.13	–	ns
T_{AH}, T_{WH}	Hold time of the F/G address inputs or the write enable input after the active transition at the CLK input of the distributed RAM	0.01	–	0.01	–	ns
Clock Pulse Width						
T_{WPH}, T_{WPL}	Minimum High or Low pulse width at CLK input	0.88	–	1.01	–	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8.

Table 32: **CLB Shift Register Switching Characteristics**

Symbol	Description	-5		-4		Units
		Min	Max	Min	Max	
Clock-to-Output Times						
T_{REG}	Time from the active edge at the CLK input to data appearing on the shift register output	–	4.11	–	4.82	ns
Setup Times						
T_{SRLDS}	Setup time of data at the BX or BY input before the active transition at the CLK input of the shift register	0.13	–	0.18	–	ns
Hold Times						
T_{SRLDH}	Hold time of the BX or BY data input after the active transition at the CLK input of the shift register	0.16	–	0.16	–	ns
Clock Pulse Width						
T_{WPH}, T_{WPL}	Minimum High or Low pulse width at CLK input	0.90	–	1.01	–	ns

Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8.

Table 47: **Master Mode CCLK Output Frequency by *ConfigRate* Option Setting**

Symbol	Description	*ConfigRate* Setting	Temperature Range	Minimum	Maximum	Units
F_{CCLK1}	Equivalent CCLK clock frequency by ***ConfigRate*** setting	1 *(power-on value)*	Commercial	0.400	0.797	MHz
			Industrial		0.847	MHz
F_{CCLK3}		3	Commercial	1.20	2.42	MHz
			Industrial		2.57	MHz
F_{CCLK6}		6 (default)	Commercial	2.40	4.83	MHz
			Industrial		5.13	MHz
F_{CCLK7}		7	Commercial	2.80	5.61	MHz
			Industrial		5.96	MHz
F_{CCLK8}		8	Commercial	3.20	6.41	MHz
			Industrial		6.81	MHz
F_{CCLK10}		10	Commercial	4.00	8.12	MHz
			Industrial		8.63	MHz
F_{CCLK12}		12	Commercial	4.80	9.70	MHz
			Industrial		10.31	MHz
F_{CCLK13}		13	Commercial	5.20	10.69	MHz
			Industrial		11.37	MHz
F_{CCLK17}		17	Commercial	6.80	13.74	MHz
			Industrial		14.61	MHz
F_{CCLK22}		22	Commercial	8.80	18.44	MHz
			Industrial		19.61	MHz
F_{CCLK25}		25	Commercial	10.00	20.90	MHz
			Industrial		22.23	MHz
F_{CCLK27}		27	Commercial	10.80	22.39	MHz
			Industrial		23.81	MHz
F_{CCLK33}		33	Commercial	13.20	27.48	MHz
			Industrial		29.23	MHz
F_{CCLK44}		44	Commercial	17.60	37.60	MHz
			Industrial		40.00	MHz
F_{CCLK50}		50	Commercial	20.00	44.80	MHz
			Industrial		47.66	MHz
$F_{CCLK100}$		100	Commercial	40.00	88.68	MHz
			Industrial		94.34	MHz

Table 48: **Master Mode CCLK Output Minimum Low and High Time**

Symbol	Description		*ConfigRate* Setting															Units
			1	3	6	7	8	10	12	13	17	22	25	27	33	44	50	100	
T_{MCCL}, T_{MCCH}	Master Mode CCLK Minimum Low and High Time	Commercial	595	196	98.3	84.5	74.1	58.4	48.9	44.1	34.2	25.6	22.3	20.9	17.1	12.3	10.4	5.3	ns
		Industrial	560	185	92.6	79.8	69.8	55.0	46.0	41.8	32.3	24.2	21.4	20.0	16.2	11.9	10.0	5.0	ns

Table 49: **Slave Mode CCLK Input Low and High Time**

Symbol	Description	Min	Max	Units
T_{SCCL}, T_{SCCH}	CCLK Low and High time	5	∞	ns

Serial Peripheral Interface (SPI) Configuration Timing

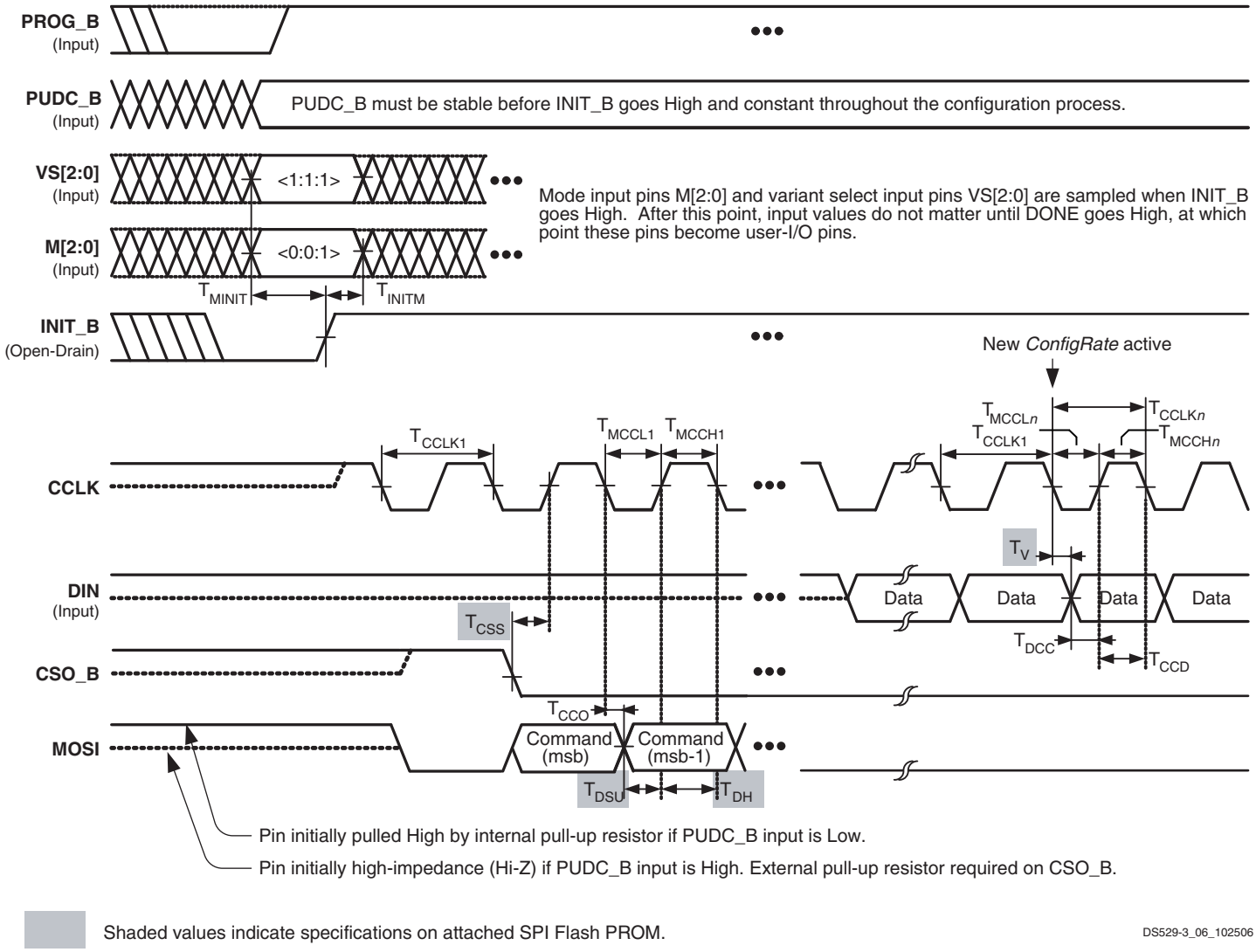


Figure 14: **Waveforms for Serial Peripheral Interface (SPI) Configuration**

Table 52: **Timing for Serial Peripheral Interface (SPI) Configuration Mode**

Symbol	Description	Minimum	Maximum	Units
T_{CCLK1}	Initial CCLK clock period	See Table 46		
T_{CCLKn}	CCLK clock period after FPGA loads ***ConfigRate*** bitstream option setting	See Table 46		
T_{MINIT}	Setup time on VS[2:0] variant-select pins and M[2:0] mode pins before the rising edge of INIT_B	50	–	ns
T_{INITM}	Hold time on VS[2:0] variant-select pins and M[2:0] mode pins after the rising edge of INIT_B	0	–	ns
T_{CCO}	MOSI output valid delay after CCLK falling clock edge	See Table 50		
T_{DCC}	Setup time on the DIN data input before CCLK rising clock edge	See Table 50		
T_{CCD}	Hold time on the DIN data input after CCLK rising clock edge	See Table 50		

Table 53: **Configuration Timing Requirements for Attached SPI Serial Flash**

Symbol	Description	Requirement	Units
T_{CCS}	SPI serial Flash PROM chip-select time	$T_{CCS} \leq T_{MCCL1} - T_{CCO}$	ns
T_{DSU}	SPI serial Flash PROM data input setup time	$T_{DSU} \leq T_{MCCL1} - T_{CCO}$	ns
T_{DH}	SPI serial Flash PROM data input hold time	$T_{DH} \leq T_{MCCH1}$	ns
T_V	SPI serial Flash PROM data clock-to-output time	$T_V \leq T_{MCCLn} - T_{DCC}$	ns
f_C or f_R	Maximum SPI serial Flash PROM clock frequency (also depends on specific read command used)	$f_C \geq \frac{1}{T_{CCLKn(min)}}$	MHz

Notes:

1. These requirements are for successful FPGA configuration in SPI mode, where the FPGA generates the CCLK signal. The post-configuration timing can be different to support the specific needs of the application loaded into the FPGA.
2. Subtract additional printed circuit board routing delay as required by the application.

FG320: 320-ball Fine-pitch Ball Grid Array

The 320-ball fine-pitch ball grid array package, FG320, supports two Spartan-3A FPGAs, the XC3S200A and the XC3S400A, as shown in Table 77 and Figure 23.

The FG320 package is an 18 x 18 array of solder balls minus the four center balls.

Table 77 lists all the package pins. They are sorted by bank number and then by pin name of the largest device. Pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The shaded rows indicate pinout differences between the XC3S200A and the XC3S400A FPGAs. The XC3S200A has three unconnected balls, indicated as N.C. (No Connection) in Table 77 and with the black diamond character (◆) in Table 77 and Figure 23.

All other balls have nearly identical functionality on all three devices. Table 80 summarizes the Spartan-3A FPGA footprint migration differences for the FG320 package.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at

www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip.

Pinout Table

Table 77: **Spartan-3A FG320 Pinout**

Bank	Pin Name	FG320 Ball	Type
0	IO_L01N_0	C15	I/O
0	IO_L01P_0	C16	I/O
0	IO_L02N_0	A16	I/O
0	IO_L02P_0/VREF_0	B16	VREF
0	IO_L03N_0	A14	I/O
0	IO_L03P_0	A15	I/O
0	IO_L04N_0	C14	I/O
0	IO_L04P_0	B15	I/O
0	IO_L05N_0	D12	I/O
0	IO_L05P_0	C13	I/O
0	IO_L06N_0/VREF_0	A13	VREF
0	IO_L06P_0	B13	I/O
0	IO_L07N_0	B12	I/O
0	IO_L07P_0	C12	I/O
0	IO_L08N_0	F11	I/O
0	IO_L08P_0	E11	I/O
0	IO_L09N_0	A11	I/O
0	IO_L09P_0	B11	I/O
0	IO_L10N_0	D10	I/O
0	IO_L10P_0	C11	I/O
0	IO_L11N_0/GCLK5	C9	GCLK
0	IO_L11P_0/GCLK4	B10	GCLK
0	IO_L12N_0/GCLK7	B9	GCLK
0	IO_L12P_0/GCLK6	A10	GCLK
0	IO_L13N_0/GCLK9	B7	GCLK
0	IO_L13P_0/GCLK8	A8	GCLK
0	IO_L14N_0/GCLK11	C8	GCLK
0	IO_L14P_0/GCLK10	B8	GCLK
0	IO_L15N_0	C7	I/O
0	IO_L15P_0	D8	I/O
0	IO_L16N_0	E9	I/O
0	IO_L16P_0	D9	I/O
0	IO_L17N_0	B6	I/O
0	IO_L17P_0	A6	I/O
0	IO_L18N_0/VREF_0	A4	VREF
0	IO_L18P_0	A5	I/O
0	IO_L19N_0	E7	I/O
0	IO_L19P_0	F8	I/O
0	IO_L20N_0	D6	I/O
0	IO_L20P_0	C6	I/O
0	IO_L21N_0	A3	I/O
0	IO_L21P_0	B4	I/O
0	IO_L22N_0	D5	I/O
0	IO_L22P_0	C5	I/O
0	IO_L23N_0	A2	I/O
0	IO_L23P_0	B3	I/O
0	IO_L24N_0/PUDC_B	E5	DUAL
0	IO_L24P_0/VREF_0	E6	VREF
0	IP_0	D13	INPUT
0	IP_0	D14	INPUT
0	IP_0	E12	INPUT
0	***XC3S400A:*** IP_0 ***XC3S200A:*** N.C. (◆)	E13	INPUT
0	IP_0	F7	INPUT
0	IP_0	F9	INPUT
0	IP_0	F10	INPUT

Table 77: **Spartan-3A FG320 Pinout*(Continued)***

Bank	Pin Name	FG320 Ball	Type
0	IP_0	F12	INPUT
0	IP_0	G7	INPUT
0	IP_0	G8	INPUT
0	IP_0	G9	INPUT
0	IP_0	G11	INPUT
0	IP_0/VREF_0	E10	VREF
0	VCCO_0	B5	VCCO
0	VCCO_0	B14	VCCO
0	VCCO_0	D11	VCCO
0	VCCO_0	E8	VCCO
1	IO_L01N_1/LDC2	T17	DUAL
1	IO_L01P_1/HDC	R16	DUAL
1	IO_L02N_1/LDC0	U18	DUAL
1	IO_L02P_1/LDC1	U17	DUAL
1	IO_L03N_1/A1	R17	DUAL
1	IO_L03P_1/A0	T18	DUAL
1	IO_L05N_1	N16	I/O
1	IO_L05P_1	P16	I/O
1	IO_L06N_1	M14	I/O
1	IO_L06P_1	N15	I/O
1	IO_L07N_1/VREF_1	P18	VREF
1	IO_L07P_1	R18	I/O
1	IO_L09N_1/A3	M17	DUAL
1	IO_L09P_1/A2	M16	DUAL
1	IO_L10N_1/A5	N18	DUAL
1	IO_L10P_1/A4	N17	DUAL
1	IO_L11N_1/A7	L12	DUAL
1	IO_L11P_1/A6	L13	DUAL
1	IO_L13N_1/A9	K16	DUAL
1	IO_L13P_1/A8	L17	DUAL
1	IO_L14N_1/RHCLK1	K17	RHCLK
1	IO_L14P_1/RHCLK0	L18	RHCLK
1	IO_L15N_1/TRDY1/RHCLK3	J17	RHCLK
1	IO_L15P_1/RHCLK2	K18	RHCLK
1	IO_L17N_1/RHCLK5	K15	RHCLK
1	IO_L17P_1/RHCLK4	J16	RHCLK
1	IO_L18N_1/RHCLK7	H17	RHCLK
1	IO_L18P_1/IRDY1/RHCLK6	H18	RHCLK
1	IO_L19N_1/A11	G16	DUAL
1	IO_L19P_1/A10	H16	DUAL

Table 77: **Spartan-3A FG320 Pinout*(Continued)***

Bank	Pin Name	FG320 Ball	Type
1	IO_L21N_1	F17	I/O
1	IO_L21P_1	G17	I/O
1	IO_L22N_1/A13	E18	DUAL
1	IO_L22P_1/A12	F18	DUAL
1	IO_L23N_1/A15	H15	DUAL
1	IO_L23P_1/A14	J14	DUAL
1	IO_L25N_1	D17	I/O
1	IO_L25P_1	D18	I/O
1	IO_L26N_1/A17	E16	DUAL
1	IO_L26P_1/A16	F16	DUAL
1	IO_L27N_1/A19	F15	DUAL
1	IO_L27P_1/A18	G15	DUAL
1	IO_L29N_1/A21	E15	DUAL
1	IO_L29P_1/A20	D16	DUAL
1	IO_L30N_1/A23	B18	DUAL
1	IO_L30P_1/A22	C18	DUAL
1	IO_L31N_1/A25	B17	DUAL
1	IO_L31P_1/A24	C17	DUAL
1	IP_L04N_1/VREF_1	N14	VREF
1	IP_L04P_1	P15	INPUT
1	IP_L08N_1/VREF_1	L14	VREF
1	IP_L08P_1	M13	INPUT
1	IP_L12N_1	L16	INPUT
1	IP_L12P_1/VREF_1	M15	VREF
1	IP_L16N_1	K14	INPUT
1	IP_L16P_1	K13	INPUT
1	IP_L20N_1	J13	INPUT
1	IP_L20P_1/VREF_1	K12	VREF
1	IP_L24N_1	G14	INPUT
1	IP_L24P_1	H13	INPUT
1	IP_L28N_1	G13	INPUT
1	IP_L28P_1/VREF_1	H12	VREF
1	IP_L32N_1	F13	INPUT
1	IP_L32P_1/VREF_1	F14	VREF
1	VCCO_1	E17	VCCO
1	VCCO_1	H14	VCCO
1	VCCO_1	L15	VCCO
1	VCCO_1	P17	VCCO
2	IO_L01N_2/M0	U3	DUAL
2	IO_L01P_2/M1	T3	DUAL

Table 81: **Spartan-3A FG400 Pinout*(Continued)***

Bank	Pin Name	FG400 Ball	Type
3	IO_L34P_3	U1	I/O
3	IO_L36N_3	T4	I/O
3	IO_L36P_3	R5	I/O
3	IO_L37N_3	V2	I/O
3	IO_L37P_3	V1	I/O
3	IO_L38N_3	W2	I/O
3	IO_L38P_3	W1	I/O
3	IP_3	H7	INPUT
3	IP_L04N_3/VREF_3	G6	VREF
3	IP_L04P_3	G7	INPUT
3	IP_L11N_3/VREF_3	J7	VREF
3	IP_L11P_3	J8	INPUT
3	IP_L15N_3	K7	INPUT
3	IP_L15P_3	K8	INPUT
3	IP_L19N_3	K5	INPUT
3	IP_L19P_3	K6	INPUT
3	IP_L23N_3	L6	INPUT
3	IP_L23P_3	L7	INPUT
3	IP_L27N_3	M7	INPUT
3	IP_L27P_3	M8	INPUT
3	IP_L31N_3	N7	INPUT
3	IP_L31P_3	M6	INPUT
3	IP_L35N_3	N6	INPUT
3	IP_L35P_3	P5	INPUT
3	IP_L39N_3/VREF_3	P7	VREF
3	IP_L39P_3	P6	INPUT
3	VCCO_3	E2	VCCO
3	VCCO_3	H5	VCCO
3	VCCO_3	L2	VCCO
3	VCCO_3	N5	VCCO
3	VCCO_3	U2	VCCO
GND	GND	A1	GND
GND	GND	A11	GND
GND	GND	A20	GND
GND	GND	B6	GND
GND	GND	B14	GND
GND	GND	C3	GND
GND	GND	C18	GND
GND	GND	D9	GND
GND	GND	E5	GND

Table 81: **Spartan-3A FG400 Pinout*(Continued)***

Bank	Pin Name	FG400 Ball	Type
GND	GND	E12	GND
GND	GND	F15	GND
GND	GND	G2	GND
GND	GND	G19	GND
GND	GND	H8	GND
GND	GND	H13	GND
GND	GND	J9	GND
GND	GND	J11	GND
GND	GND	K1	GND
GND	GND	K10	GND
GND	GND	K12	GND
GND	GND	K17	GND
GND	GND	L4	GND
GND	GND	L9	GND
GND	GND	L11	GND
GND	GND	L20	GND
GND	GND	M10	GND
GND	GND	M12	GND
GND	GND	N8	GND
GND	GND	N11	GND
GND	GND	N13	GND
GND	GND	P2	GND
GND	GND	P19	GND
GND	GND	R6	GND
GND	GND	R9	GND
GND	GND	T16	GND
GND	GND	U12	GND
GND	GND	V3	GND
GND	GND	V18	GND
GND	GND	W7	GND
GND	GND	W15	GND
GND	GND	Y1	GND
GND	GND	Y10	GND
GND	GND	Y20	GND
VCCAUX	SUSPEND	R15	PWR MGMT
VCCAUX	DONE	W19	CONFIG
VCCAUX	PROG_B	D5	CONFIG
VCCAUX	TCK	A19	JTAG
VCCAUX	TDI	F5	JTAG

FG484: 484-ball Fine-pitch Ball Grid Array

The 484-ball fine-pitch ball grid array, FG484, supports both the XC3S700A and the XC3S1400A FPGAs. There are three pinout differences, as described in Table 86.

Table 83 lists all the FG484 package pins. They are sorted by bank number and then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The shaded rows indicate pinout differences between the XC3S700A and the XC3S1400A FPGAs. The XC3S700A has three unconnected balls, indicated as N.C. (No Connection) in Table 83 and with the black diamond character (◆) in Table 83 and Figure 25.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at

www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip.

Pinout Table

Table 83: **Spartan-3A FG484 Pinout**

Bank	Pin Name	FG484 Ball	Type
0	IO_L01N_0	D18	I/O
0	IO_L01P_0	E17	I/O
0	IO_L02N_0	C19	I/O
0	IO_L02P_0/VREF_0	D19	VREF
0	IO_L03N_0	A20	I/O
0	IO_L03P_0	B20	I/O
0	IO_L04N_0	F15	I/O
0	IO_L04P_0	E15	I/O
0	IO_L05N_0	A18	I/O
0	IO_L05P_0	C18	I/O
0	IO_L06N_0	A19	I/O
0	IO_L06P_0/VREF_0	B19	VREF
0	IO_L07N_0	C17	I/O
0	IO_L07P_0	D17	I/O
0	IO_L08N_0	C16	I/O
0	IO_L08P_0	D16	I/O
0	IO_L09N_0	E14	I/O
0	IO_L09P_0	C14	I/O
0	IO_L10N_0	A17	I/O
0	IO_L10P_0	B17	I/O
0	IO_L11N_0	C15	I/O
0	IO_L11P_0	D15	I/O
0	IO_L12N_0/VREF_0	A15	VREF
0	IO_L12P_0	A16	I/O
0	IO_L13N_0	A14	I/O
0	IO_L13P_0	B15	I/O
0	IO_L14N_0	E13	I/O
0	IO_L14P_0	F13	I/O
0	IO_L15N_0	C13	I/O
0	IO_L15P_0	D13	I/O
0	IO_L16N_0	A13	I/O
0	IO_L16P_0	B13	I/O
0	IO_L17N_0/GCLK5	E12	GCLK
0	IO_L17P_0/GCLK4	C12	GCLK
0	IO_L18N_0/GCLK7	A11	GCLK
0	IO_L18P_0/GCLK6	A12	GCLK
0	IO_L19N_0/GCLK9	C11	GCLK
0	IO_L19P_0/GCLK8	B11	GCLK
0	IO_L20N_0/GCLK11	E11	GCLK
0	IO_L20P_0/GCLK10	D11	GCLK
0	IO_L21N_0	C10	I/O
0	IO_L21P_0	A10	I/O
0	IO_L22N_0	A8	I/O
0	IO_L22P_0	A9	I/O
0	IO_L23N_0	E10	I/O
0	IO_L23P_0	D10	I/O
0	IO_L24N_0/VREF_0	C9	VREF
0	IO_L24P_0	B9	I/O
0	IO_L25N_0	C8	I/O
0	IO_L25P_0	B8	I/O
0	IO_L26N_0	A6	I/O
0	IO_L26P_0	A7	I/O
0	IO_L27N_0	C7	I/O
0	IO_L27P_0	D7	I/O
0	IO_L28N_0	A5	I/O
0	IO_L28P_0	B6	I/O
0	IO_L29N_0	D6	I/O
0	IO_L29P_0	C6	I/O
0	IO_L30N_0	D8	I/O

Table 83: **Spartan-3A FG484 Pinout *(Continued)***

Table 83: **Spartan-3A FG484 Pinout*(Continued)***

Bank	Pin Name	FG484 Ball	Type
0	IO_L30P_0	E9	I/O
0	IO_L31N_0	B4	I/O
0	IO_L31P_0	A4	I/O
0	IO_L32N_0	D5	I/O
0	IO_L32P_0	C5	I/O
0	IO_L33N_0	B3	I/O
0	IO_L33P_0	A3	I/O
0	IO_L34N_0	F8	I/O
0	IO_L34P_0	E7	I/O
0	IO_L35N_0	E6	I/O
0	IO_L35P_0	F7	I/O
0	IO_L36N_0/PUDC_B	A2	DUAL
0	IO_L36P_0/VREF_0	B2	VREF
0	IP_0	E16	INPUT
0	IP_0	E8	INPUT
0	IP_0	F10	INPUT
0	IP_0	F12	INPUT
0	IP_0	F16	INPUT
0	IP_0	G10	INPUT
0	IP_0	G11	INPUT
0	IP_0	G12	INPUT
0	IP_0	G13	INPUT
0	IP_0	G14	INPUT
0	IP_0	G15	INPUT
0	IP_0	G16	INPUT
0	IP_0	G7	INPUT
0	IP_0	G9	INPUT
0	IP_0	H10	INPUT
0	IP_0	H13	INPUT
0	IP_0	H14	INPUT
0	IP_0/VREF_0	G8	VREF
0	IP_0/VREF_0	H12	VREF
0	IP_0/VREF_0	H9	VREF
0	VCCO_0	B10	VCCO
0	VCCO_0	B14	VCCO
0	VCCO_0	B18	VCCO
0	VCCO_0	B5	VCCO
0	VCCO_0	F14	VCCO
0	VCCO_0	F9	VCCO
1	IO_L01N_1/LDC2	Y21	DUAL

Table 83: **Spartan-3A FG484 Pinout*(Continued)***

Bank	Pin Name	FG484 Ball	Type
1	IO_L01P_1/HDC	AA22	DUAL
1	IO_L02N_1/LDC0	W20	DUAL
1	IO_L02P_1/LDC1	W19	DUAL
1	IO_L03N_1/A1	T18	DUAL
1	IO_L03P_1/A0	T17	DUAL
1	IO_L05N_1	W21	I/O
1	IO_L05P_1	Y22	I/O
1	IO_L06N_1	V20	I/O
1	IO_L06P_1	V19	I/O
1	IO_L07N_1	V22	I/O
1	IO_L07P_1	W22	I/O
1	IO_L09N_1	U21	I/O
1	IO_L09P_1	U22	I/O
1	IO_L10N_1	U19	I/O
1	IO_L10P_1	U20	I/O
1	IO_L11N_1	T22	I/O
1	IO_L11P_1	T20	I/O
1	IO_L13N_1	T19	I/O
1	IO_L13P_1	R20	I/O
1	IO_L14N_1	R22	I/O
1	IO_L14P_1	R21	I/O
1	IO_L15N_1/VREF_1	P22	VREF
1	IO_L15P_1	P20	I/O
1	IO_L17N_1/A3	P18	DUAL
1	IO_L17P_1/A2	R19	DUAL
1	IO_L18N_1/A5	N21	DUAL
1	IO_L18P_1/A4	N22	DUAL
1	IO_L19N_1/A7	N19	DUAL
1	IO_L19P_1/A6	N20	DUAL
1	IO_L20N_1/A9	N17	DUAL
1	IO_L20P_1/A8	N18	DUAL
1	IO_L21N_1/RHCLK1	L22	RHCLK
1	IO_L21P_1/RHCLK0	M22	RHCLK
1	IO_L22N_1/TRDY1/RHCLK3	L20	RHCLK
1	IO_L22P_1/RHCLK2	L21	RHCLK
1	IO_L24N_1/RHCLK5	M20	RHCLK
1	IO_L24P_1/RHCLK4	M18	RHCLK
1	IO_L25N_1/RHCLK7	K19	RHCLK
1	IO_L25P_1/IRDY1/RHCLK6	K20	RHCLK
1	IO_L26N_1/A11	J22	DUAL

Table 87: **Spartan-3A FG676 Pinout*(Continued)***

Bank	Pin Name	FG676 Ball	Type
0	IO_L34N_0	D10	I/O
0	IO_L34P_0	C10	I/O
0	IO_L35N_0	H12	I/O
0	IO_L35P_0	G12	I/O
0	IO_L36N_0	B9	I/O
0	IO_L36P_0	A9	I/O
0	IO_L37N_0	D9	I/O
0	IO_L37P_0	E10	I/O
0	IO_L38N_0	B8	I/O
0	IO_L38P_0	A8	I/O
0	IO_L39N_0	K12	I/O
0	IO_L39P_0	J12	I/O
0	IO_L40N_0	D8	I/O
0	IO_L40P_0	C8	I/O
0	IO_L41N_0	C6	I/O
0	IO_L41P_0	B6	I/O
0	IO_L42N_0	C7	I/O
0	IO_L42P_0	B7	I/O
0	IO_L43N_0	K11	I/O
0	IO_L43P_0	J11	I/O
0	IO_L44N_0	D6	I/O
0	IO_L44P_0	C5	I/O
0	IO_L45N_0	B4	I/O
0	IO_L45P_0	A4	I/O
0	IO_L46N_0	H10	I/O
0	IO_L46P_0	G10	I/O
0	IO_L47N_0	H9	I/O
0	IO_L47P_0	G9	I/O
0	IO_L48N_0	E7	I/O
0	IO_L48P_0	F7	I/O
0	IO_L51N_0	B3	I/O
0	IO_L51P_0	A3	I/O
0	IO_L52N_0/PUDC_B	G8	DUAL
0	IO_L52P_0/VREF_0	F8	VREF
0	IP_0	A5	INPUT
0	IP_0	A7	INPUT
0	IP_0	A13	INPUT
0	IP_0	A17	INPUT
0	IP_0	A23	INPUT
0	IP_0	C4	INPUT

Table 87: **Spartan-3A FG676 Pinout*(Continued)***

Bank	Pin Name	FG676 Ball	Type
0	IP_0	D12	INPUT
0	IP_0	D15	INPUT
0	IP_0	D19	INPUT
0	IP_0	E11	INPUT
0	IP_0	E18	INPUT
0	IP_0	E20	INPUT
0	IP_0	F10	INPUT
0	IP_0	G14	INPUT
0	IP_0	G16	INPUT
0	IP_0	H13	INPUT
0	IP_0	H18	INPUT
0	IP_0	J10	INPUT
0	IP_0	J13	INPUT
0	IP_0	J15	INPUT
0	IP_0/VREF_0	D7	VREF
0	IP_0/VREF_0	D14	VREF
0	IP_0/VREF_0	G11	VREF
0	IP_0/VREF_0	J17	VREF
0	N.C. (◆)	A24	N.C.
0	N.C. (◆)	B24	N.C.
0	N.C. (◆)	D5	N.C.
0	N.C. (◆)	E9	N.C.
0	N.C. (◆)	F18	N.C.
0	N.C. (◆)	E6	N.C.
0	N.C. (◆)	F9	N.C.
0	N.C. (◆)	G18	N.C.
0	VCCO_0	B5	VCCO
0	VCCO_0	B11	VCCO
0	VCCO_0	B16	VCCO
0	VCCO_0	B22	VCCO
0	VCCO_0	E8	VCCO
0	VCCO_0	E13	VCCO
0	VCCO_0	E19	VCCO
0	VCCO_0	H11	VCCO
0	VCCO_0	H16	VCCO
1	IO_L01N_1/LDC2	Y21	DUAL
1	IO_L01P_1/HDC	Y20	DUAL
1	IO_L02N_1/LDC0	AD25	DUAL
1	IO_L02P_1/LDC1	AE26	DUAL
1	IO_L03N_1/A1	AC24	DUAL

Table 87: **Spartan-3A FG676 Pinout*(Continued)***

Bank	Pin Name	FG676 Ball	Type
2	IO_L16N_2	W12	I/O
2	IO_L16P_2	V12	I/O
2	IO_L17N_2/VS2	AA12	DUAL
2	IO_L17P_2/RDWR_B	Y12	DUAL
2	IO_L18N_2	AF8	I/O
2	IO_L18P_2	AE8	I/O
2	IO_L19N_2/VS0	AF9	DUAL
2	IO_L19P_2/VS1	AE9	DUAL
2	IO_L20N_2	W13	I/O
2	IO_L20P_2	V13	I/O
2	IO_L21N_2	AC12	I/O
2	IO_L21P_2	AB12	I/O
2	IO_L22N_2/D6	AF10	DUAL
2	IO_L22P_2/D7	AE10	DUAL
2	IO_L23N_2	AC11	I/O
2	IO_L23P_2	AD11	I/O
2	IO_L24N_2/D4	AE12	DUAL
2	IO_L24P_2/D5	AF12	DUAL
2	IO_L25N_2/GCLK13	Y13	GCLK
2	IO_L25P_2/GCLK12	AA13	GCLK
2	IO_L26N_2/GCLK15	AE13	GCLK
2	IO_L26P_2/GCLK14	AF13	GCLK
2	IO_L27N_2/GCLK1	AA14	GCLK
2	IO_L27P_2/GCLK0	Y14	GCLK
2	IO_L28N_2/GCLK3	AE14	GCLK
2	IO_L28P_2/GCLK2	AF14	GCLK
2	IO_L29N_2	AC14	I/O
2	IO_L29P_2	AD14	I/O
2	IO_L30N_2/MOSI/CSI_B	AB15	DUAL
2	IO_L30P_2	AC15	I/O
2	IO_L31N_2	W15	I/O
2	IO_L31P_2	V14	I/O
2	IO_L32N_2/DOUT	AE15	DUAL
2	IO_L32P_2/AWAKE	AD15	PWR MGMT
2	IO_L33N_2	AD17	I/O
2	IO_L33P_2	AE17	I/O
2	IO_L34N_2/D3	Y15	DUAL
2	IO_L34P_2/INIT_B	AA15	DUAL
2	IO_L35N_2	U15	I/O

Table 87: **Spartan-3A FG676 Pinout*(Continued)***

Bank	Pin Name	FG676 Ball	Type
2	IO_L35P_2	V15	I/O
2	IO_L36N_2/D1	AE18	DUAL
2	IO_L36P_2/D2	AF18	DUAL
2	IO_L37N_2	AE19	I/O
2	IO_L37P_2	AF19	I/O
2	IO_L38N_2	AB16	I/O
2	IO_L38P_2	AC16	I/O
2	IO_L39N_2	AE20	I/O
2	IO_L39P_2	AF20	I/O
2	IO_L40N_2	AC19	I/O
2	IO_L40P_2	AD19	I/O
2	IO_L41N_2	AC20	I/O
2	IO_L41P_2	AD20	I/O
2	IO_L42N_2	U16	I/O
2	IO_L42P_2	V16	I/O
2	IO_L43N_2	Y17	I/O
2	IO_L43P_2	AA17	I/O
2	IO_L44N_2	AD21	I/O
2	IO_L44P_2	AE21	I/O
2	IO_L45N_2	AC21	I/O
2	IO_L45P_2	AD22	I/O
2	IO_L46N_2	V17	I/O
2	IO_L46P_2	W17	I/O
2	IO_L47N_2	AA18	I/O
2	IO_L47P_2	AB18	I/O
2	IO_L48N_2	AE23	I/O
2	IO_L48P_2	AF23	I/O
2	IO_L51N_2	AE25	I/O
2	IO_L51P_2	AF25	I/O
2	IO_L52N_2/CCLK	AE24	DUAL
2	IO_L52P_2/D0/DIN/MISO	AF24	DUAL
2	IP_2	AA19	INPUT
2	IP_2	AB13	INPUT
2	IP_2	AB17	INPUT
2	IP_2	AB20	INPUT
2	IP_2	AC7	INPUT
2	IP_2	AC13	INPUT
2	IP_2	AC17	INPUT
2	IP_2	AC18	INPUT
2	IP_2	AD9	INPUT